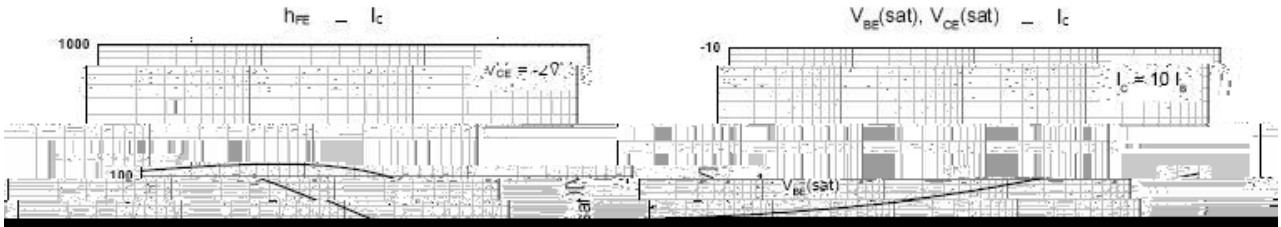
TO-252 PNP

/ Electrical Characteristic Curve



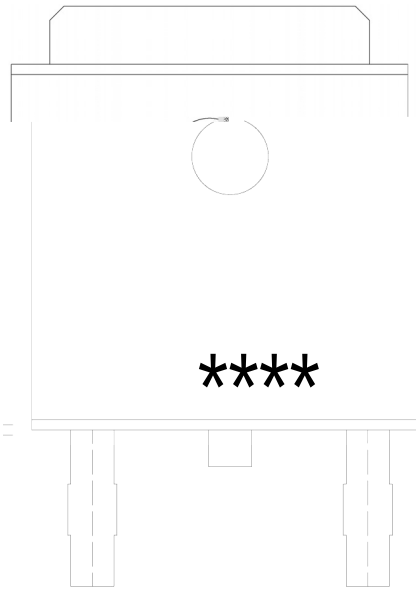
/ Package Dimensions



0.00	0.10	D1	5.10	5.50	K

TO-252

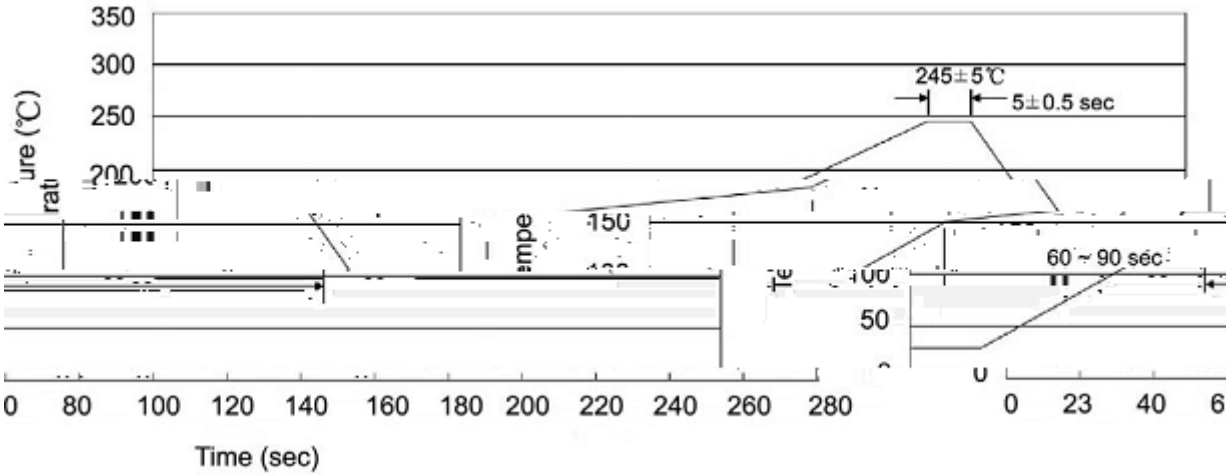
/ Marking Instructions



MJD32C

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( ) / Temperature Profile for IR Reflow Soldering(Pb-Free)



± ± ± ±

/ Resistance to Soldering Heat Test Conditions

± ±

/ Packaging SPEC.

	Units/Reel / Reels/Inner Box / Units/Inner Box /	